

**S07Z**

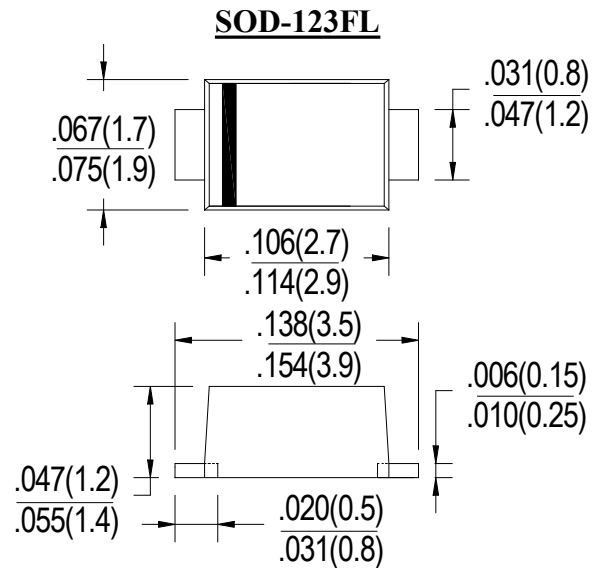
**0.7AMPS. SURFACE MOUNT GENERAL PURPOSE SILICON RECTIFIERS**

**FEATURES**

- Glass passivated device
- Ideal for surface mounted applications
- Low reverse leakage
- Metallurgically bonded construction
- High temperature soldering guaranteed:  
250°C/10 seconds at terminals.

**MECHANICAL DATA**

- Case: JEDEC SOD-123FL,molded plastic over passivated chip
- Terminals:Solder Plated, solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Weight: 0.006 ounces, 0.02 gram
- Mounting position: Any



Dimensions in inches and (millimeters)

**MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS**

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz,resistive or inductive load.

For capacitive load, derate current by 20%.

Type Number	SYM	S07Z	units
	BOL		
	marking	SZ	
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	2000	V
Maximum RMS Voltage	$V_{RMS}$	1400	V
Maximum DC Blocking Voltage	$V_{DC}$	2000	V
Maximum Average Forward rectified Current	$I_{F(AV)}$	0.7	A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rate load (JEDEC method)	$I_{FSM}$	25	A
Maximum forward Voltage at 0.7A DC	$V_F$	1.2	V
Maximum DC Reverse Current @ $T_J=25^\circ\text{C}$ at rated DC blocking voltage @ $T_J=125^\circ\text{C}$	$I_R$	5.0	$\mu\text{A}$
		200.0	
Typical Junction Capacitance (Note 1)	$C_J$	5	pF
Typical thermal resistance (Note 2)	$R_{(JA)}$	180	$^\circ\text{C} / \text{W}$
	$R_{(JC)}$	28	
Storage Temperature Range	$T_{STG}$	-55 to +150	$^\circ\text{C}$
Operation Temperature Range	$T_J$	-55 to +150	$^\circ\text{C}$

**Note:**

1. Measured at 1MHz and applied reverse voltage of 4.0 volts d.c.
2. Measured on P.C.Board with 0.2×0.2”(5.0×5.0mm)Copper Pad Areas

RATING AND CHARACTERISTIC CURVES

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

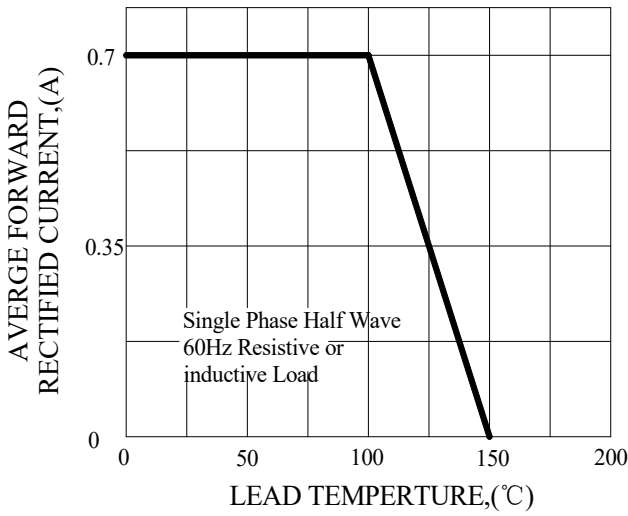


FIG.2-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

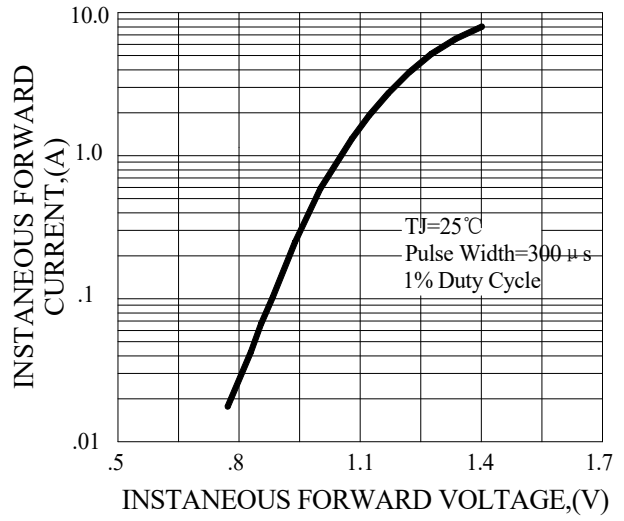


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

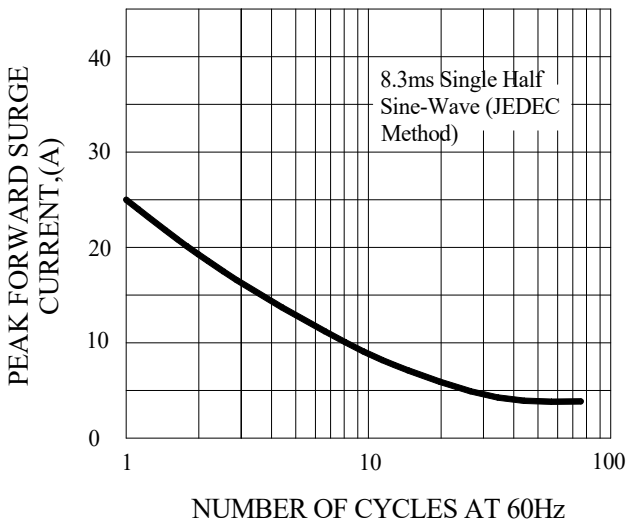
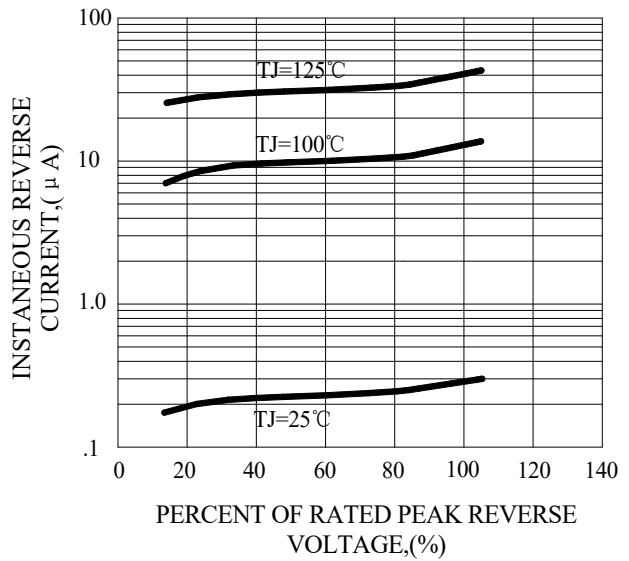
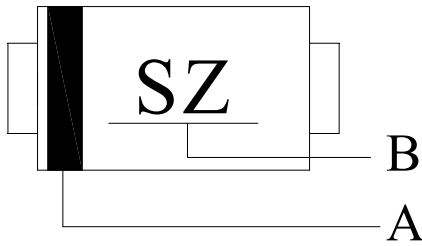


FIG.4-TYPICAL REVERSE CHARACTERISTICS



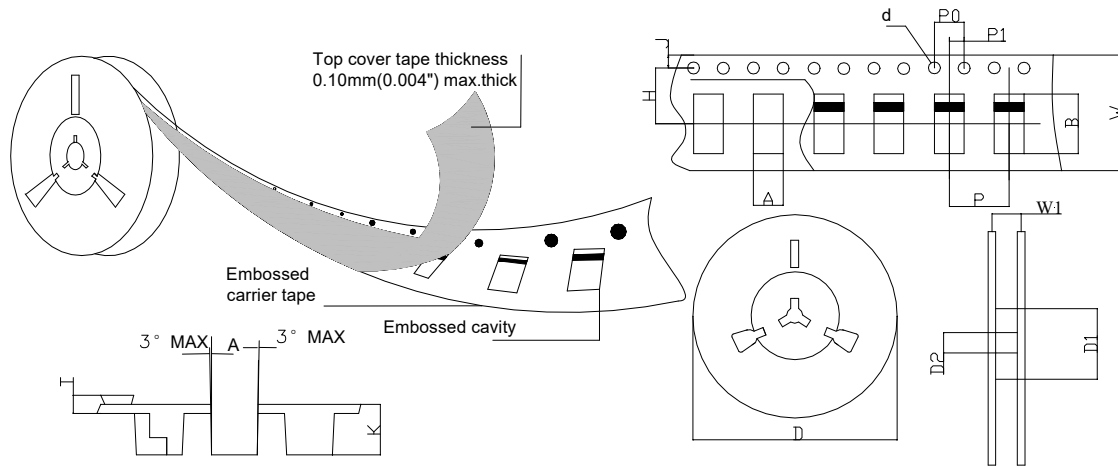
## Marking and packaging illustration

### 1、Marking



SYMBOL	Explanation
A	Color Band Denotes Cathode
B	Product Name

### 2、Packaging



SPECIFICATIONS mm(inch)		PACKAGE	SPECIFICATIONS mm(inch)		PACKAGE
ITEM	SYM BOL	SOD-123FL	ITEM	SYM BOL	SOD-123FL
Carrier width	A	2.1(0.083)Max	Carrier depth	K	1.60(0.063)Typ
Carrier length	B	4.0(0.157)Max	Punch hole pitch	P	4.00(0.157)Typ
Sprocket hole	d	ø1.55(0.061)Typ	Sprocket hole pitch	P0	4.00(0.157)Typ
Reel outer diameter	D	177.8(7)Typ	Embossment center	P1	2.00(0.079)Typ
Reel inner diameter	D1	50.0(1.969)Min	Overall tape thickness	T	0.25(0.098)Typ
Feed hole diameter	D2	13.0(0.512)Typ	Tape width	W	8.15(0.321)Typ
Sprocket hole position	J	1.75(0.069)Typ	Reel width	W1	10.5(0.413)Min
Punch hole position	H	3.50(0.138)Typ			